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*Nikko Materials to License TCR Product to Gould Management Group PR Newswire US February 6, 2006 Monday 9:47 PM GMT*

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February 6, 2006 Monday 9:47 PM GMT

**LENGTH:** 407 words**HEADLINE:** Nikko **Materials** to License TCR Product to **Gould** Management Group**DATELINE:** CHANDLER, Ariz. Feb. 6**BODY:**

CHANDLER, Ariz., Feb. 6 /PRNewswire/ -- Nikko **Materials** Company, Ltd. announced it will license technology for its TCR embedded resistor product to a management group from its **Gould Electronics** subsidiary. The group is headed by David P. Burgess, current president of **Gould Electronics**.

Nikko **Materials** has previously announced plans to close its Chandler, AZ, manufacturing facility and U.S. headquarters by April 2006.

The new company will be formed in the first quarter of 2006. Machinery and laboratory equipment used to support the TCR product will be relocated from the current **Gould** foil factory to a new site in the Chandler area. Burgess said, "We are currently manufacturing and selling TCR embedded resistor foil to our customers and our plans call for little or no disruption in our supply capability during the short time needed to relocate to our new facility. The new company will retain several key personnel who contributed to the development of patented technology supporting the embedded resistor product."

"**Gould** developed TCR thin film resistor foil to meet the ever increasing challenges of packaging high speed, high density **electronic** devices. Integrating passive components into the circuit board using TCR foil can quickly and reliably improve electrical performance and give designers the edge they need," said Burgess.

Burgess said, "The new company will retain a collaborative relationship with Nikko **Materials**."

Nikko has a strong technical base in metals and sputtering targets, which will be vital in the development of new resistor products. Alternatively, the new company's technical staff has been involved in TCR product development and marketing since its inception four years ago, and this experience can be leveraged by Nikko to quickly grow the TCR market in Europe, Japan and Southeast Asia."

Additional details regarding the TCR product can be found on the **Gould Electronics** web site <http://www.gould.com/>.

Nikko **Materials** USA, Inc., a subsidiary of Nikko **Materials** Co. Ltd., produces electrodeposited copper foil for printed circuit board manufacturers and laminators under the **Gould** brand, and sputtering targets for semiconductor applications, flat panel displays and data storage devices under the Nikko **Materials** brand.

First Call Analyst:

FCMN Contact:

Website: <http://www.gould.com>

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